

RKD751KP

Silicon Schottky Barrier Diode for Detector

REJ03G1485-0200
Rev.2.00
Feb 22, 2007

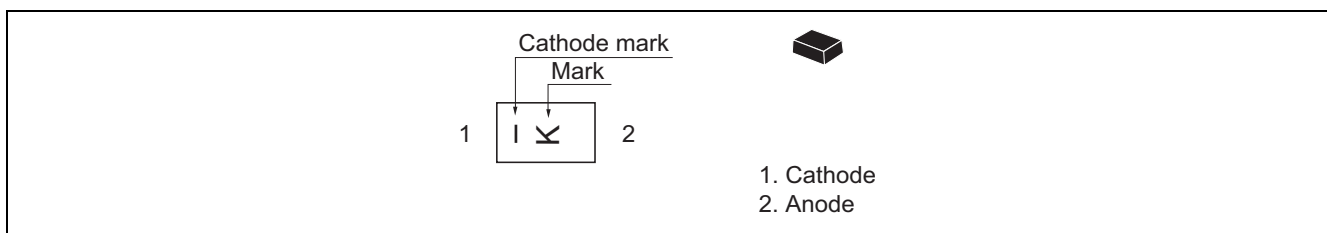
Features

- High forward current, Low capacitance.
- Halogen free, Environmental friendly Package include Conformity to RoHS Directive.
- Ultra small Package (0.6mm×0.3mm Size leadless type)

Ordering Information

Part No.	Laser Mark	Package Name	Package Code
RKD751KP	K	MP6	PXSN0002ZB-A

Pin Arrangement



Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Value	Unit
Repetitive peak reverse voltage	V_{RRM}	5	V
Reverse voltage	V_R	3	V
Average rectified current	I_o	30	mA
Junction temperature	T_j	125	°C
Storage temperature	T_{stg}	-55 to +125	°C

Electrical Characteristics

(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse voltage	V_R	3.0	—	—	V	$I_R = 1 \text{ mA}$
Reverse current	I_R	—	—	50	μA	$V_R = 0.5 \text{ V}$
Forward current	I_F	35	—	—	mA	$V_F = 0.5 \text{ V}$
Capacitance	C	—	—	1.0	pF	$V_R = 0.5 \text{ V}, f = 1 \text{ MHz}$
ESD-Capability *1	—	30	—	—	V	C = 200 pF, $R_L = 0 \Omega$, Both forward and reverse direction 1 pulse.

Notes: 1. Failure criterion ; $I_R > 100 \mu\text{A}$ at $V_R = 0.5 \text{ V}$

2. Please do not use the soldering iron due to avoid high stress to the MP6 package.

Main Characteristics

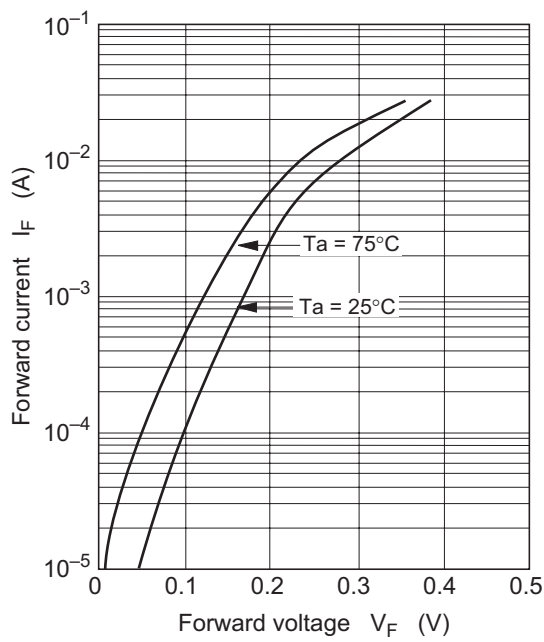


Fig.1 Forward current vs. Forward voltage

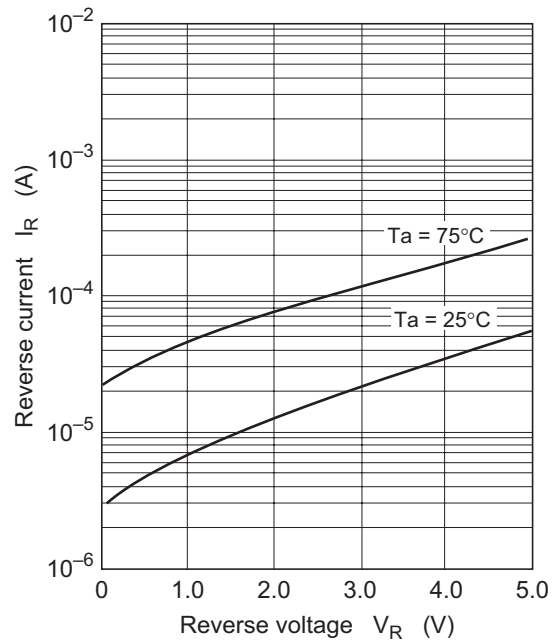


Fig.2 Reverse current vs. Reverse voltage

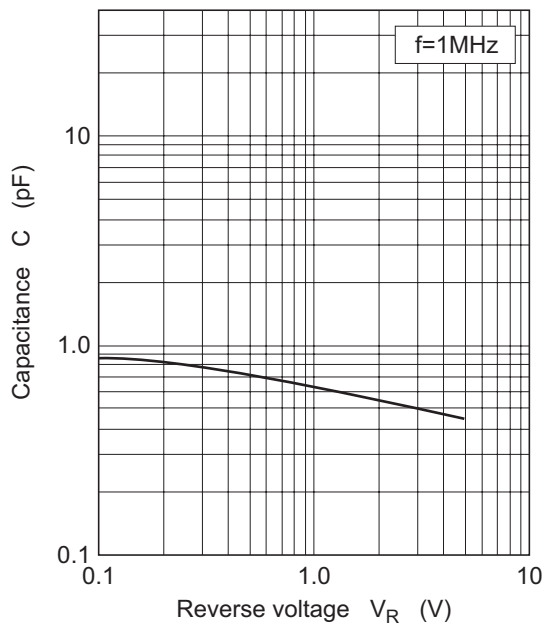
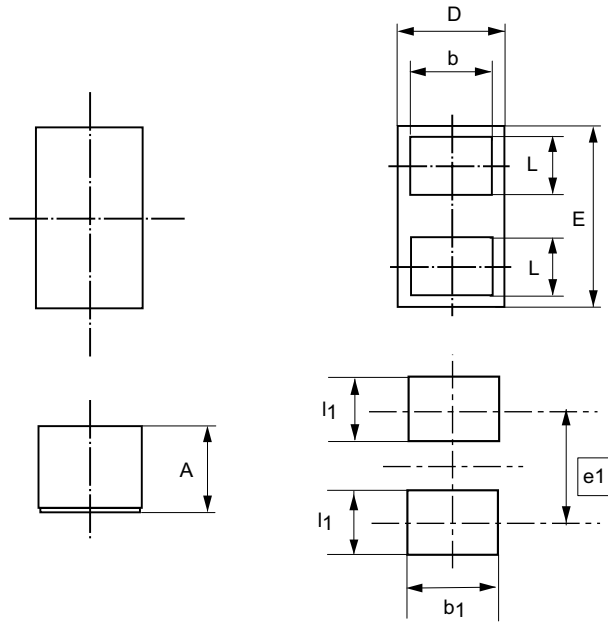


Fig.3 Capacitance vs. Reverse voltage

Package Dimensions

Package Name	JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
MP6	—	PXSN0002ZB-A	MP6V	0.00015g



Pattern of terminal position areas

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
A	0.27	0.30	0.33
b	0.25	0.27	0.29
D	0.29	0.32	0.35
E	0.59	0.62	0.65
L	0.17	0.19	0.21
b1	—	0.31	—
e1	—	0.38	—
l1	—	0.23	—

Notes:

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